PATENTS ORDINANCE (Chapter 514)

NOTICE OF SPECIFICATION OF FORMS

Pursuant to section 150 of the Patents Ordinance (Chapter 514), notice is hereby given that the form specified below and attached to this notice shall, with effect from 14 March 2005, be used in connection with the proceeding described below:-

Form no. Description of Proceedings Fee no.

P9 Maintaining application for standard patent under section 33 of the 11, 12
Ordinance and section 28 of the Patents (General) Rules

This notice shall, on 14 March 2005, supersede the Notice of Specification of Forms in relation to Form P9 published in the Hong Kong Intellectual Property Journal on 7 May 2004.

11 March 2005

Stephen SELBY Registrar of Patents



Patents Form P9

Maintaining application for standard patent

Patents Ordinance (Cap. 514)
Patents (General) Rules (Cap. 514C)

General notes

- a. Please complete this form in English unless otherwise stated.
- b. This form must be signed and dated.
- c. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheets.
- d. Please provide a name and contact address in Hong Kong, China for correspondence.
- e. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.info.gov.hk/ipd

Submission of application/request

In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong, China.

Use of personal data

Personal data provided in this form will be used by the Intellectual Property Department and can be disclosed for purposes relating to the administration of the Patents Ordinance and its subsidiary legislation. Registration will protect your intellectual property rights and information in this form is used to process your application. You can obtain information regarding access to and alteration of your personal data in accordance with the Patents Ordinance and its subsidiary legislation by contacting the Registrar of Patents.

01	Your reference				
		<u>I</u>			
Note 1	Note 1 This form is for one patent application.				
02	Application no. (Note 1)				
03	Full name of the applicant(s)				
Nam	Name				
Name in Chinese (if applicable)					

04	Statements in support				
	As at the specified date:				
	(enter a date on which the following statements are valid. The date entered should not be earlier than 1 month before the date of making the application.)		(DD-MM-YYYY)		
			Please mark the appropriate box(es)		
	(a) the designated patent application has not been withdrawn or abandoned in the designated patent office				
	(b)	the designated patent application has not been finally refused in the designated patent office			
	(c)	the designated patent has not been granted			
		or			
		the designated patent has been granted. The patent was granted on a date within 6 months before the date of the maintenance application			
		Date of grant of the designated patent	(DD-MM-YYYY)		
(section 33(5), Patents Ordinance, which can be viewed at www.info.gov.hk/ipd)					
Note 2 You should pay the maintenance fee before the expiry date (but not earlier than three months before the expiry date). You can still apply to maintain the patent application within six months after the expiry date but you have to pay the prescribed additional fee.					
05		nent of maintenance fee additional fee for late payment)			
	(a)	Due date of maintenance fee (DD-MM-YYYY)			
	(b)	If you are paying late, how many months late?			
	(c)	Are you paying an additional fee? (Note 2)	Please mark the appropriate box ☐ Yes ☐ No		

06	Overdue payment notice will be sent to the address for service recorded on the register. If you wish the notice to be sent to an address in Hong Kong, China other than the address for service, please mark "Yes" and give details of the address. (sections 28(2) and (3), Patents (General) Rules, which can be viewed at www.info.gov.hk/ipd)	☐ Yes	□ No	
	Address			
07	Contact name and address for person filing this application			
	Name			
	Address			
	Talanhana na			
	Telephone no. Facsimile no.			
	E-mail address			
08	Signature			
Signa		Official Capacity of S		te (DD-MM-YYYY)
09	State the number of additional sheet(s)	attached to this for	n	